

MOS FIELD EFFECT TRANSISTOR

μ PA1872B

N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

The μ PA1872B is a switching device, which can be driven directly by a 2.5 V power source.

The μ PA1872B features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- 2.5 V drive available
- Low on-state resistance
 - $R_{DS(on)1} = 13.0 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4.5 \text{ V, } I_D = 5.0 \text{ A)}$
 - $R_{DS(on)2} = 13.5 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4.0 \text{ V, } I_D = 5.0 \text{ A)}$
 - $R_{DS(on)3} = 15.5 \text{ m}\Omega \text{ MAX. (} V_{GS} = 3.1 \text{ V, } I_D = 5.0 \text{ A)}$
 - $R_{DS(on)4} = 18.0 \text{ m}\Omega \text{ MAX. (} V_{GS} = 2.5 \text{ V, } I_D = 5.0 \text{ A)}$
- Built-in G-S protection diode against ESD

ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA1872BGR-9JG	Power TSSOP8

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Drain to Source Voltage ($V_{GS} = 0 \text{ V}$)	V_{DSS}	20.0	V
Gate to Source Voltage ($V_{DS} = 0 \text{ V}$)	V_{GSS}	± 12.0	V
Drain Current (DC) ^{Note 1}	$I_{D(DC)}$	± 10.0	A
Drain Current (pulse) ^{Note 2}	$I_{D(pulse)}$	± 80.0	A
Total Power Dissipation ^{Note 1}	P_T	2.0	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	$-55 \text{ to } +150$	$^\circ\text{C}$

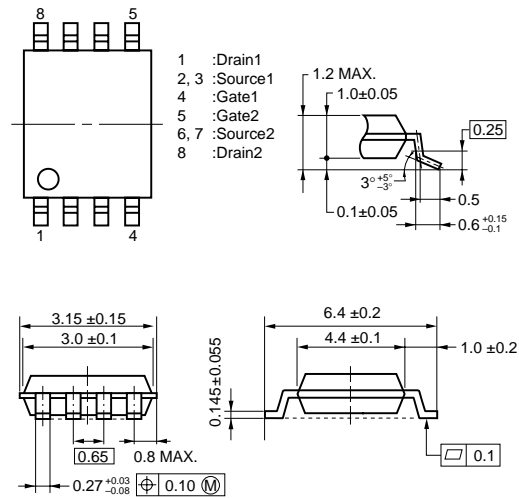
Notes 1. Mounted on ceramic board of $50 \text{ cm}^2 \times 1.1 \text{ mm}$

2. $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$

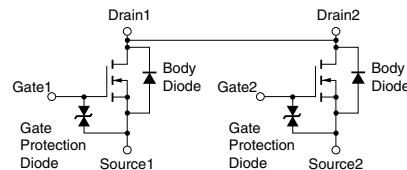
Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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PACKAGE DRAWING (Unit: mm)



EQUIVALENT CIRCUIT

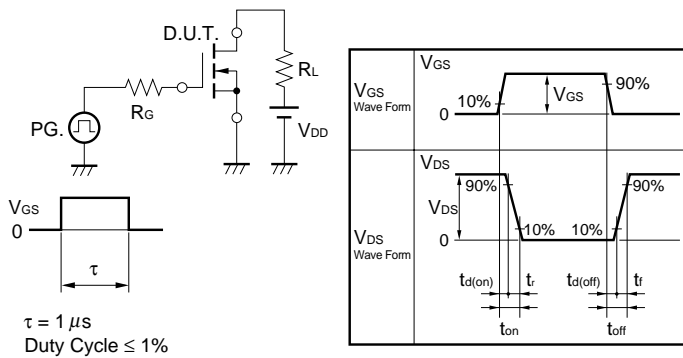


ELECTRICAL CHARACTERISTICS (TA = 25°C)

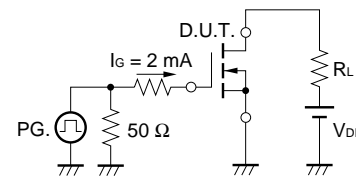
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 20.0\text{ V}, V_{GS} = 0\text{ V}$			1.0	μA
Gate Leakage Current	I_{GSS}	$V_{GS} = \pm 12.0\text{ V}, V_{DS} = 0\text{ V}$			± 10.0	μA
Gate Cut-off Voltage	$V_{GS(off)}$	$V_{DS} = 10.0\text{ V}, I_D = 1.0\text{ mA}$	0.50	1.00	1.50	V
Forward Transfer Admittance ^{Note}	$ y_{fs} $	$V_{DS} = 10.0\text{ V}, I_D = 5.0\text{ A}$	5			S
Drain to Source On-state Resistance ^{Note}	$R_{DS(on)1}$	$V_{GS} = 4.5\text{ V}, I_D = 5.0\text{ A}$	8.0	10.0	13.0	$\text{m}\Omega$
	$R_{DS(on)2}$	$V_{GS} = 4.0\text{ V}, I_D = 5.0\text{ A}$	8.5	10.5	13.5	$\text{m}\Omega$
	$R_{DS(on)3}$	$V_{GS} = 3.1\text{ V}, I_D = 5.0\text{ A}$	9.0	11.0	15.5	$\text{m}\Omega$
	$R_{DS(on)4}$	$V_{GS} = 2.5\text{ V}, I_D = 5.0\text{ A}$	10.0	13.0	18.0	$\text{m}\Omega$
Input Capacitance	C_{iss}	$V_{DS} = 10.0\text{ V}$		945		pF
Output Capacitance	C_{oss}	$V_{GS} = 0\text{ V}$		220		pF
Reverse Transfer Capacitance	C_{rss}	$f = 1.0\text{ MHz}$		160		pF
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 10.0\text{ V}, I_D = 5.0\text{ A}$		47		ns
Rise Time	t_r	$V_{GS} = 4.0\text{ V}$		315		ns
Turn-off Delay Time	$t_{d(off)}$	$R_G = 10\ \Omega$		255		ns
Fall Time	t_f			330		ns
Total Gate Charge	Q_G	$V_{DD} = 16.0\text{ V}$		10.0		nC
Gate to Source Charge	Q_{GS}	$V_{GS} = 4.0\text{ V}$		2.5		nC
Gate to Drain Charge	Q_{GD}	$I_D = 10.0\text{ A}$		4.5		nC
Body Diode Forward Voltage ^{Note}	$V_{F(S-D)}$	$I_F = 10.0\text{ A}, V_{GS} = 0\text{ V}$		0.83		V
Reverse Recovery Time	t_{rr}	$I_F = 10.0\text{ A}, V_{GS} = 0\text{ V}$		240		ns
Reverse Recovery Charge	Q_{rr}	$di/dt = 50\text{ A}/\mu\text{s}$		220		nC

Note Pulsed: $PW \leq 350\ \mu\text{s}$, Duty Cycle $\leq 2\%$

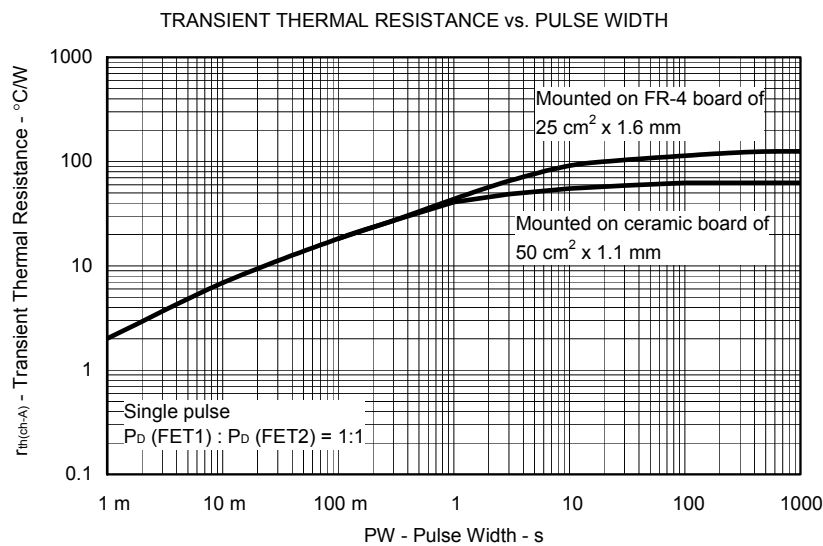
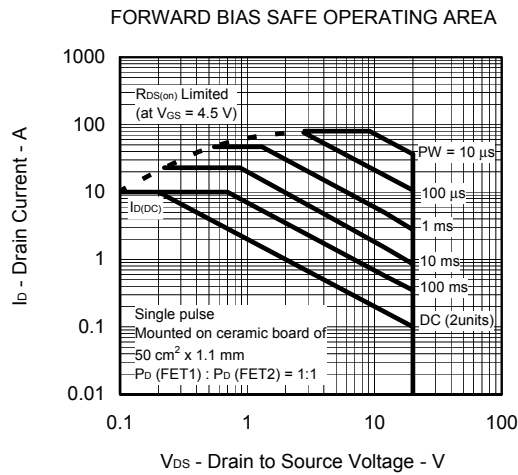
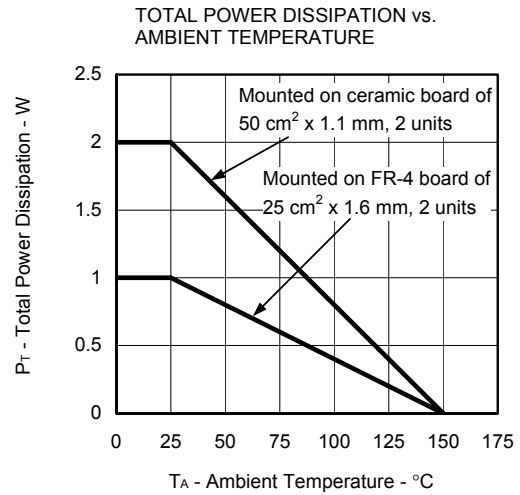
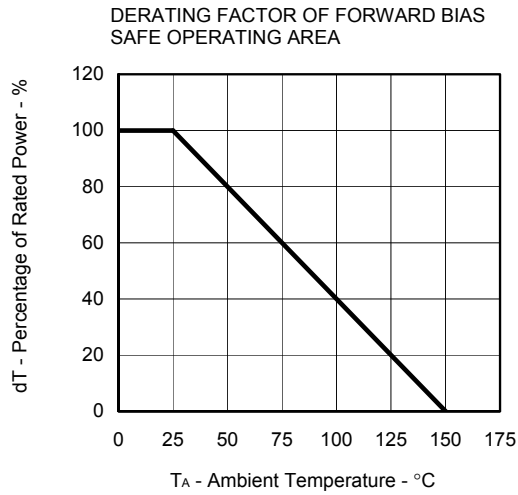
TEST CIRCUIT 1 SWITCHING TIME



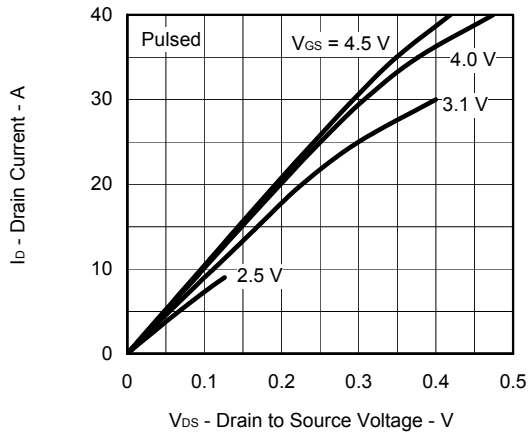
TEST CIRCUIT 2 GATE CHARGE



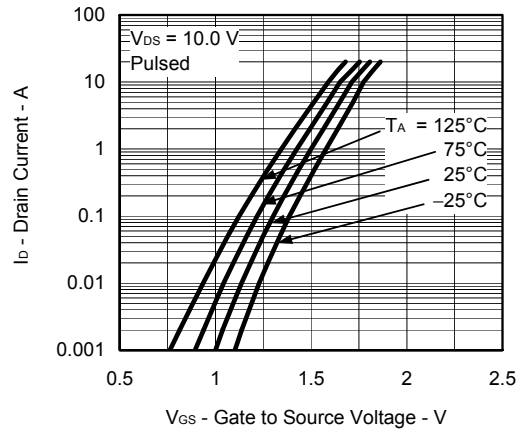
TYPICAL CHARACTERISTICS (T_A = 25°C)



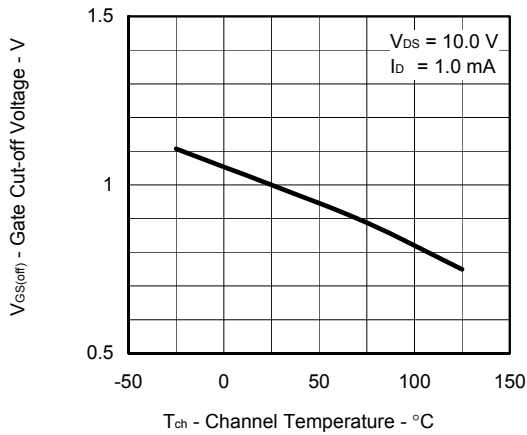
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



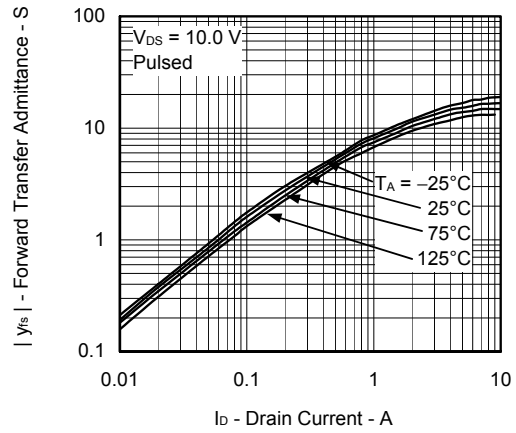
FORWARD TRANSFER CHARACTERISTICS



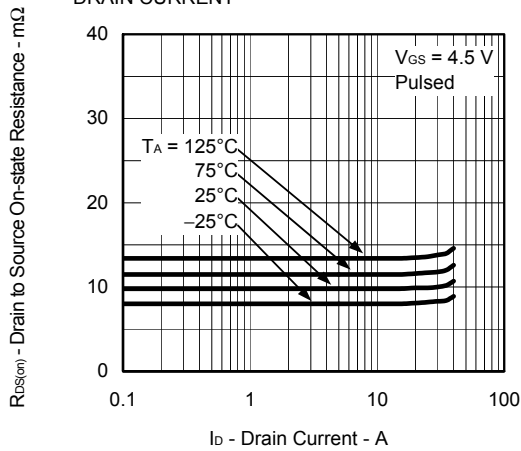
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



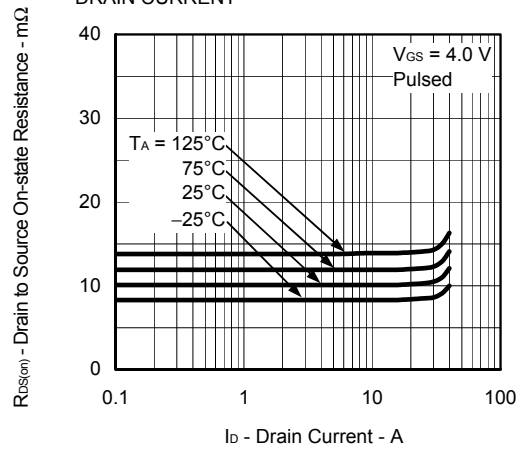
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

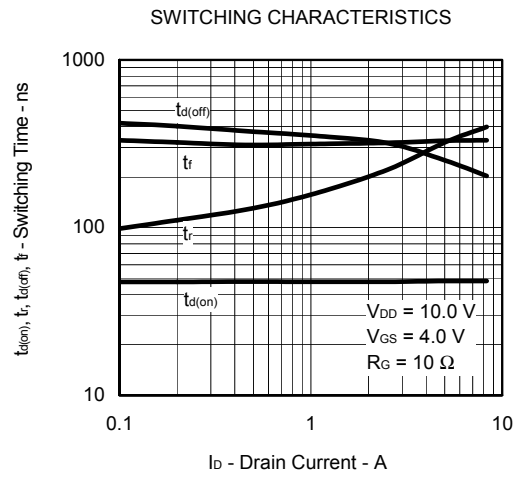
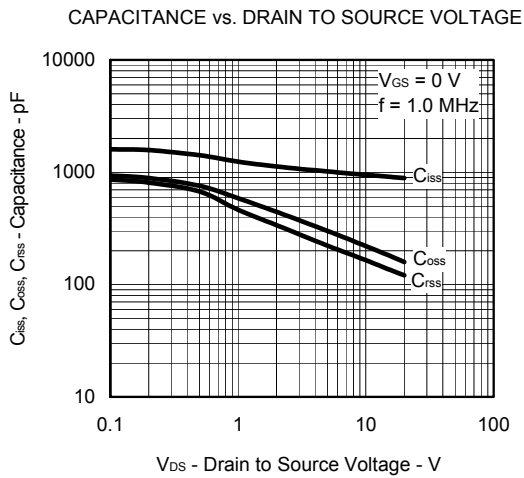
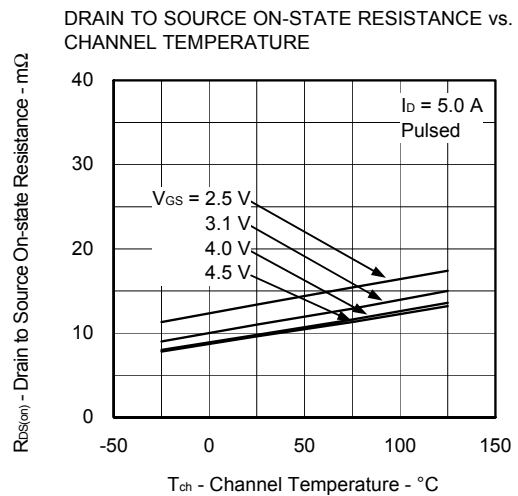
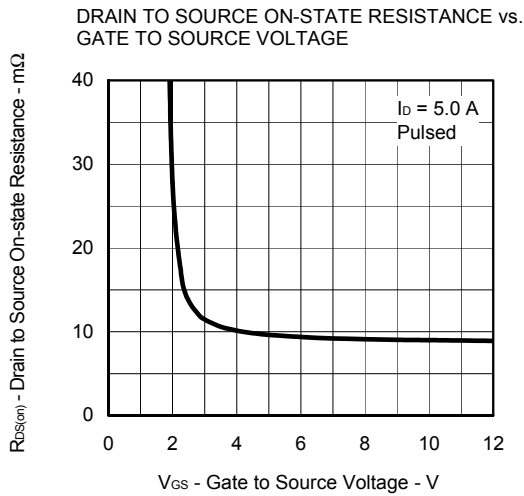
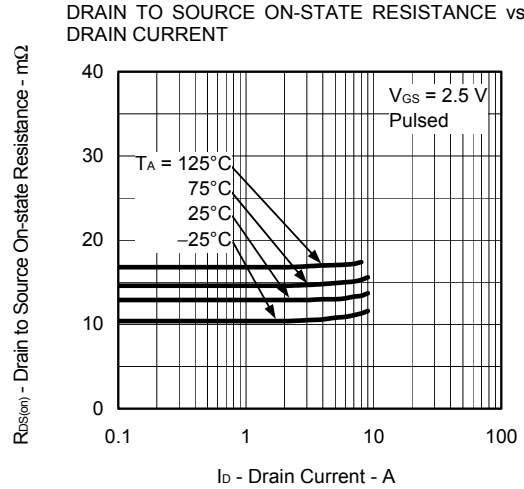
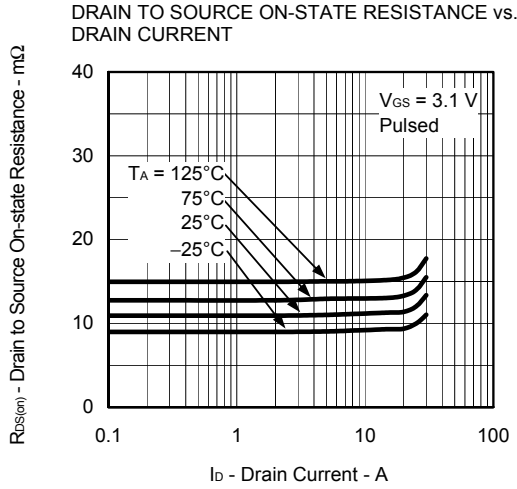


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

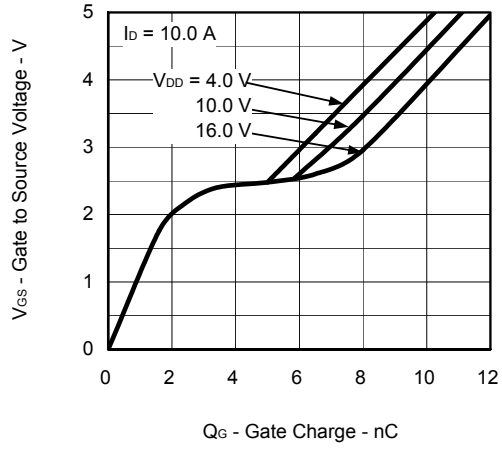


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

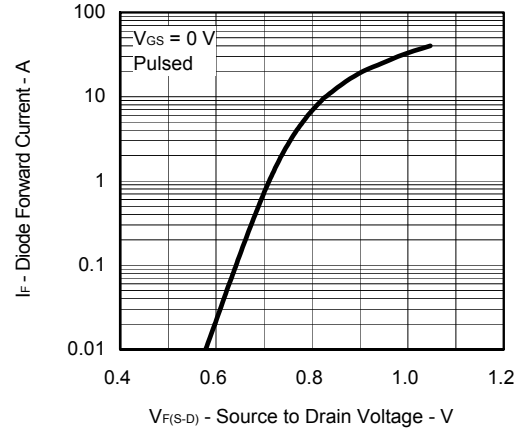




DYNAMIC INPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



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